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## Product Change Notification - JAON-08PTJN759

**Date:** 08 Jun 2016  
**Product Category:** Supertex  
**Notification subject:** CCB 2514 Initial Notice: Qualification of GTK assembly site for selected Supertex products using wafers with Au backside coating available in 3L TO-92 package.  
**Notification text:** **PCN Status:**  
 Initial notification

**Microchip Parts Affected:**  
 Please open the attachments found in the attachments field below labeled as PCN\_#\_Affected\_CPN.

NOTE: For your convenience Microchip includes identical files in two formats (.pdf and .xls).

**Description of Change:**  
 Qualification of GTK assembly site for selected Supertex products using wafers with Au backside coating available in 3L TO-92 package.

**Pre Change:**  
 Assembled at CRTK assembly site

**Post Change:**  
 Assembled at GTK assembly site

**Pre and Post Change Summary:**

	Pre Change	Post Change
<b>Assembly Site</b>	CRTK assembly site	GTK assembly site
<b>Wire material</b>	Au wire	Au wire
<b>Die attach material</b>	84-1 LMISR4	8060T
<b>Molding compound material</b>	EME-G600	G600F
<b>Lead frame material</b>	KFC	A194
<b>Die Thickness</b>	11 mil	11 mil

**Impacts to Data Sheet:**

None

**Reason for Change:**

To improve productivity by qualifying GTK assembly site.

**Change Implementation Status:**

In Progress

**Estimated Qualification Completion Date:**

Note: Please be advised the qualification completion times may be extended because of unforeseen business conditions however implementation will not occur until after qualification has completed and a final PCN has been issued. The final PCN will include the qualification report and estimated first ship date.

**Summary Table:**

	June 2016				
	22	23	24	25	26
WW					
Initial PCN Issue Date		X			
Qual Report Availability			X		
Final PCN Issue Date			X		
Estimated Implementation Date				X	

**Markings to Distinguish Revised from Unrevised Devices:**

Traceability code

**Revision History:**

**June 8, 2016:** Issued initial notification.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

**Attachment(s):**

- [PCN\\_JAON-08PTJN759\\_Qual\\_Plan.pdf](#)
- [PCN\\_JAON-08PTJN759\\_Affected\\_CPN.pdf](#)
- [PCN\\_JAON-08PTJN759\\_Affected\\_CPN.xls](#)

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Affected Catalog Part Numbers (CPN)

PCN_JAON-08PTJN759
CATALOG_PART_NBR
2N7000-G
2N7000-G-D596
2N7008-G
DN2530N3-G
DN2535N3-G
DN2535N3-G-P003
DN2535N3-G-P013
DN2540N3-G
DN2540N3-G-P003
DN3545N3-G
TN0104N3-G
TN0104N3-G-P003
TN0104N3-G-P014
TN0106N3-G
TN0106N3-G-P003
TN0106N3-G-P013
TN0110N3-G
TN0110N3-G-P002
TN0604N3-G
TN0604N3-G-P005
TN0604N3-G-P013
TN0606N3-G
TN0610N3-G
TN0610N3-G-P003
TN0610N3-G-P013
TN0620N3-G
TN0620N3-G-D163
TN0620N3-G-P002
TN0620N3-G-P014
TN0702N3-G
TN2106N3-G
TN2540N3-G
TN2540N3-G-P002
TN2640N3-G
TN5325N3-G
TN5325N3-G-P002
TP0604N3-G
TP0606N3-G
TP0606N3-G-P002
TP0606N3-G-P003
TP0620N3-G
TP2104N3-G
TP2104N3-G-P003

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Affected Catalog Part Numbers (CPN)

PCN_JAON-08PTJN759
CATALOG_PART_NBR
TP2535N3-G
TP2540N3-G
TP2540N3-G-P002
TP2635N3-G
TP2640N3-G
VN0104N3-G
VN0104N3-G-P013
VN0106N3-G
VN0106N3-G-P003
VN0109N3-G
VN0300L-G
VN0300L-G-P002
VN0550N3-G
VN0550N3-G-P013
VN0606L-G
VN0606L-G-P003
VN0808L-G
VN10KN3-G
VN10KN3-G-P002
VN10KN3-G-P003
VN10KN3-G-P013
VN10KN3-G-P014
VN1206L-G
VN1206L-G-P002
VN2106N3-G
VN2210N3-G
VN2222LL-G
VN2222LL-G-P003
VN2222LL-G-P013
VN2224N3-G
VN2406L-G
VN2410L-G
VN2410L-G-P013
VN2410L-G-P014
VN2450N3-G
VN2460N3-G
VN2460N3-G-P003
VN2460N3-G-P014
VN3205N3-G
VN3205N3-G-P002
VN4012L-G
VP0104N3-G
VP0106N3-G

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Affected Catalog Part Numbers (CPN)

PCN_JAON-08PTJN759
CATALOG_PART_NBR
VP0109N3-G
VP0550N3-G
VP0550N3-G-D559
VP0550N3-G-P013
VP0808L-G
VP2106N3-G
VP2206N3-G
VP2206N3-G-P003
VP2450N3-G
VP3203N3-G